BS EN 61340-5-1:2007

Electrostatics —

Part 5-1: Protection of electronic devices from electrostatic phenomena — General requirements

ICS 17.220.99; 29.020; 31.020



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This British Standard was

National foreword

This British Standard is the UK implementation of EN 61340-5-1:2007. It is identical to IEC 61340-5-1:2007. It supersedes BS EN 61340-5-1:2001 which is withdrawn.

The UK participation in its preparation was entrusted to Technical Committee GEL/101, Electrostatics.

A list of organizations represented on this committee can be obtained on request to its secretary.

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Amendments/corrigenda issued since publication

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Electrostatics -Part 5-1: Protection of electronic devices from electrostatic phenomena -General requirements

(IEC 61340-5-1:2007)

Electrostatique -Partie 5-1: Protection des dispositifs électroniques contre les phénomènes électrostatiques -Exigences générales (CEI 61340-5-1:2007) Elektrostatik -Teil 5-1: Schutz von elektronischen Bauelementen gegen elektrostatische Phänomene -Allgemeine Anforderungen (IEC 61340-5-1:2007)

This European Standard was approved by CENELEC on 2007-10-01. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this European Standard the status of a national standard without any alteration.

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This European Standard exists in three official versions (English, French, German). A version in any other language made by translation under the responsibility of a CENELEC member into its own language and notified to the Central Secretariat has the same status as the official versions.

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CENELEC

European Committee for Electrotechnical Standardization Comité Européen de Normalisation Electrotechnique Europäisches Komitee für Elektrotechnische Normung

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This European Standard supersedes EN 61340-5-1:2001 + corrigendum April 2001.

The main changes with respect to EN 61340-5-1:2001 are listed below:

EN 61340-5-1:2007 focuses on the requirements for an ESD control program. In addition, EN 61340-5-1:2007 has been aligned with other major ESD control program standards used throughout the world.

The following dates were fixed:

_	latest date by which the EN has to be implemented at national level by publication of an identical national standard or by endorsement	(dop)	2008-07-01
-	latest date by which the national standards conflicting with the EN have to be withdrawn	(dow)	2010-10-01

Annex ZA has been added by CENELEC.

Endorsement notice

The text of the International Standard IEC 61340-5-1:2007 was approved by CENELEC as a European Standard without any modification.

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INTRODUCTION

This part of IEC 61340 covers the requirements necessary to design, establish, implement and maintain an electrostatic discharge (ESD) control program for activities that: manufacture, process, assemble, install, package, label, service, test, inspect, transport or otherwise handle electrical or electronic parts, assemblies and equipment susceptible to damage by electrostatic discharges greater than or equal to 100 V human body model (HBM). This standard covers the ESD control program requirements necessary for setting up a program to handle ESD-sensitive devices (ESDS), based on the historical experience of both military and commercial organizations. The fundamental ESD control principles that form the basis of this standard are as follows:

- avoid a discharge from any charged, conductive object (personnel and especially automated handling equipment) into the ESDS. This can be accomplished by bonding or electrically connecting all conductors in the environment, including personnel, to a known ground or contrived ground (as on board ship or on aircraft). This attachment creates an equipotential balance between all conducting objects and personnel. Electrostatic protection can be maintained at a potential different from a "zero" voltage ground potential as long as all conductive objects in the system are at the same potential;
- avoid a discharge from any charged ESD sensitive device. Charging can result from direct contact and separation or it can be field induced. Necessary insulators in the environment cannot lose their electrostatic charge by attachment to ground. Ionization systems provide neutralization of charges on these necessary insulators (circuit board materials and some device packages are examples of necessary insulators). Assessment of the ESD hazard created by electrostatic charges on the necessary insulators in the work place is required to ensure that appropriate actions are implemented, according to the risk;
- once outside of an electrostatic discharge protected area (hereinafter referred to as an EPA) it is often not possible to control the above items, therefore, ESD protective packaging may be required. ESD protection can be achieved by enclosing ESD sensitive products in static protective materials, although the type of material depends on the situation and destination. Inside an EPA, static dissipative materials may provide adequate protection. Outside an EPA, static discharge shielding materials are recommended. Whilst all of these materials are not discussed in this standard, it is important to recognize the differences in their application.

Each company has different processes, and so will require a different blend of ESD prevention measures for an optimum ESD control program. It is vital that these measures are selected, based on technical necessity and carefully documented in an ESD control program plan, so that all concerned can be sure of the program requirements.

Training is an essential part of an ESD control program in order to ensure that the personnel involved understand the equipment and procedures they are to use in order to be in compliance with the ESD control program plan. Training is also essential in raising awareness and understanding of ESD issues. Without training, personnel are often a major source of ESD risk. With training, they become an effective first line of defence against ESD damage.

Regular compliance verification checks and tests are essential to ensure that equipment remains effective and that the ESD control program is correctly implemented in compliance with the ESD control program plan.

Any contact and physical separation of materials or flow of solids, liquids, or particle-laden gases can generate electrostatic charges. Common sources of ESD include charged: personnel, conductors, common polymeric materials, and processing equipment. ESD damage can occur when:

- a charged person or object comes into contact with an ESDS;
- an ESDS comes into direct contact with a highly conductive surface while exposed to an electrostatic field;
- a charged ESDS comes into contact with another conductive surface which is at a different electrical potential. This surface may or may not be grounded.

Examples of ESDS are microcircuits, discrete semiconductors, thick and thin film resistors, hybrid devices, printed circuit boards and piezoelectric crystals. It is possible to determine device and item susceptibility by exposing the device to simulated ESD events. The level of sensitivity, determined by test using simulated ESD events, may not necessarily relate to the level of sensitivity in a real life situation. However, they are used to establish a baseline of susceptibility data for comparison of devices with equivalent part numbers from different manufacturers. Three different models are used for characterization of electronic components - human body model (HBM), machine model (MM), and charged device model (CDM).

ELECTROSTATICS -

Part 5-1: Protection of electronic device from electrostatic phenomena – General requirements

1 Scope

This part of IEC 61340 applies to activities that: manufacture, process, assemble, install, package, label, service, test, inspect, transport or otherwise handle electrical or electronic parts, assemblies and equipment susceptible to damage by electrostatic discharges greater than or equal to 100 V human body model (HBM).

This standard provides the requirements for an ESD control program. The user should refer to IEC 61340-5-2 for guidance on the implementation of this standard.

This standard does not apply to electrically initiated explosive devices, flammable liquids, gases and powders.

The purpose of this standard is to provide the administrative and technical requirements for establishing, implementing and maintaining an ESD control program (hereinafter referred to as the "program").

2 Normative references

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60364 (all parts), *Low-voltage electrical installations*

IEC/TS 60479-1, Effects of current on human beings and livestock – Part 1: General aspects

IEC/TS 60479-2, Effects of current on human beings and livestock – Part 2: Special aspects

IEC 60749-26, Semiconductor devices – Mechanical and climatic test methods – Part 26: Electrostatic discharge (ESD) sensitivity testing – Human body model (HBM)

IEC 61010-1, Safety requirements for electrical equipment for measurement, control and laboratory use – Part 1: General requirements

IEC 61140, Protection against electric shock – Common aspects for installation and equipment

IEC 61340-2-3, *Electrostatics – Part 2-3: Methods of test for determining the resistance and resistivity of solid planar materials used to avoid electrostatic charge accumulation*

IEC 61340-4-1, *Electrostatics – Part 4-1: Standard test methods for specific applications – Electrical resistance of floor coverings and installed floors*

IEC 61340-4-3, *Electrostatics – Part 4-3: Standard test methods for specific applications – Footwear*